FOX WaferPak Contactor

Single Touchdown Full-Wafer Test & Burn-in

PRODUCT BENEFITS

- Delivers FOX system resources to the wafer enabling single touchdown test and burn-in
  - May be designed for up to 300 mm wafer sizes
  - Production proven with > 50,000 contacts per wafer
  - Pad Metallurgy: Al, Cu, Au or solder balls
  - Temperature range: Ambient to 150° C

- Supports up to 2,048 I/O and DPS channels with remote voltage and ground sense per pin
  - Handles up to 4 amps per contact

- Handles up to 2 kW of power dissipation

- Enables high volume full wafer production test and burn-in with one touchdown

- Field repairable contactor

“Setting the Test Standard for Tomorrow”